

# **Device Modeling Report**

COMPONENTS: Power MOSFET (Model parameter)  
PART NUMBER: TPCP8402  
MANUFACTURER: TOSHIBA  
Body Diode (Model parameter) / ESD Protection Diode  
Remark: Silicon N&P Channel MOS Type

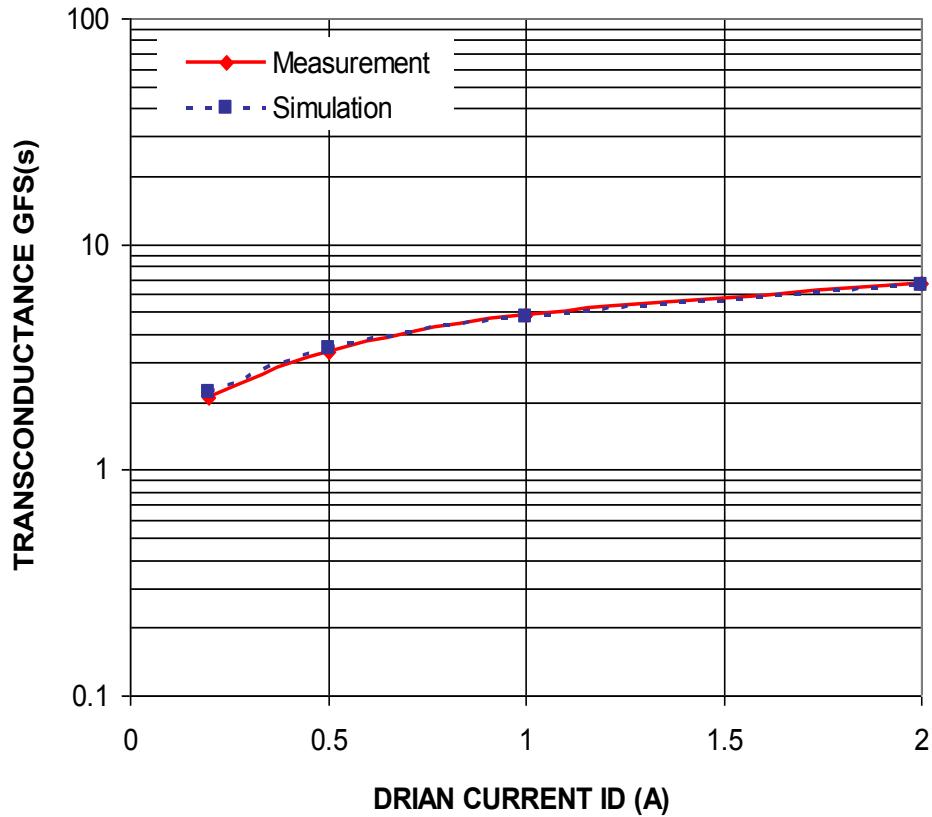


## MOSFET MODEL

PSpice model parameter	Model description
LEVEL	
L	Channel Length
W	Channel Width
KP	Transconductance
RS	Source Ohmic Resistance
RD	Ohmic Drain Resistance
VTO	Zero-bias Threshold Voltage
RDS	Drain-Source Shunt Resistance
TOX	Gate Oxide Thickness
CGSO	Zero-bias Gate-Source Capacitance
CGDO	Zero-bias Gate-Drain Capacitance
CBD	Zero-bias Bulk-Drain Junction Capacitance
MJ	Bulk Junction Grading Coefficient
PB	Bulk Junction Potential
FC	Bulk Junction Forward-bias Capacitance Coefficient
RG	Gate Ohmic Resistance
IS	Bulk Junction Saturation Current
N	Bulk Junction Emission Coefficient
RB	Bulk Series Resistance
PHI	Surface Inversion Potential
GAMMA	Body-effect Parameter
DELTA	Width effect on Threshold Voltage
ETA	Static Feedback on Threshold Voltage
THETA	Mobility Modulation
KAPPA	Saturation Field Factor
VMAX	Maximum Drift Velocity of Carriers
XJ	Metallurgical Junction Depth
UO	Surface Mobility

## P-Channel Model Transconductance Characteristic

Circuit Simulation Result



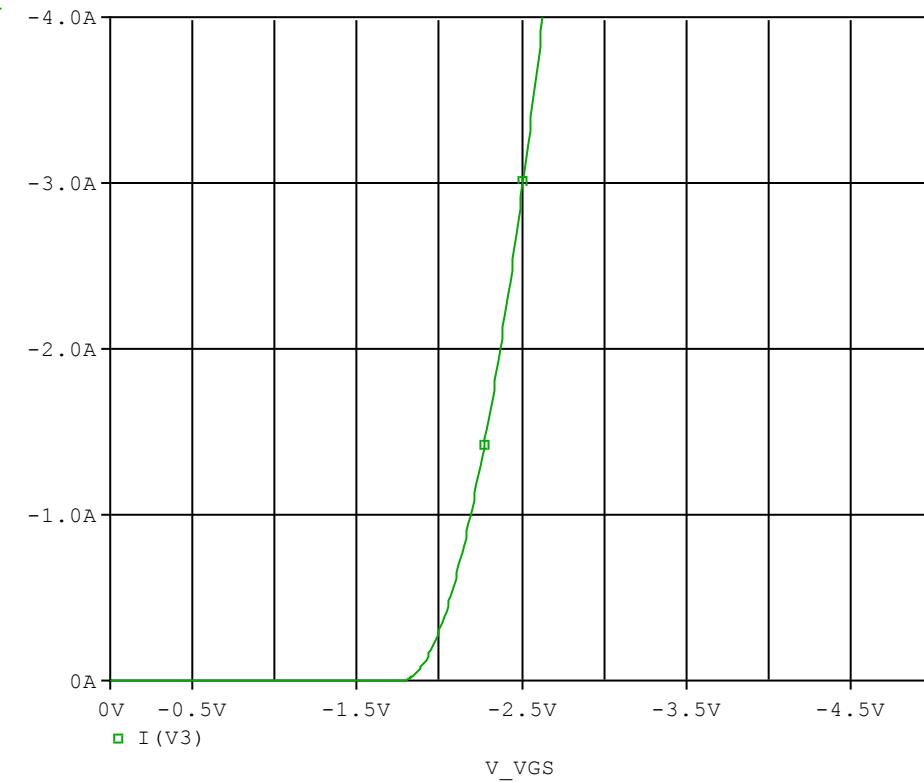
Comparison table

- Id(A)	gfs		Error(%)
	Measurement	Simulation	
0.2	2.11	2.20	4.51
0.5	3.33	3.45	3.50
1	4.83	4.78	-1.06
2	6.67	6.62	-0.75

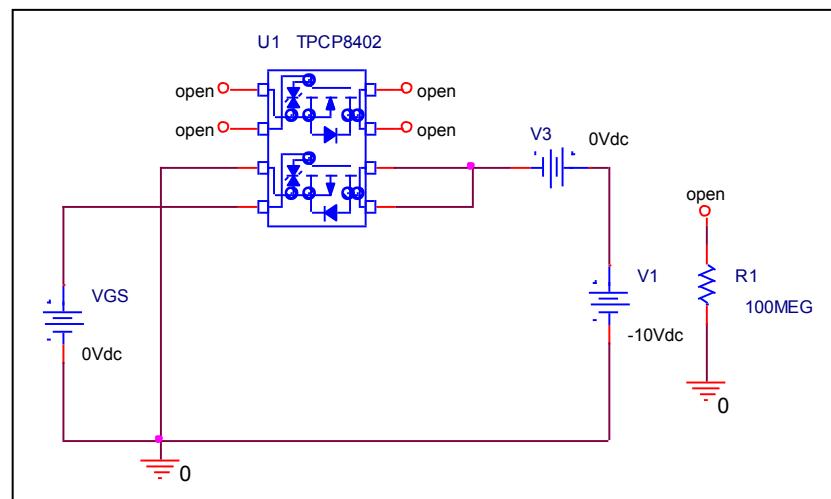
## P-Channel Model

### V<sub>gs</sub>-I<sub>d</sub> Characteristic

Circuit Simulation result

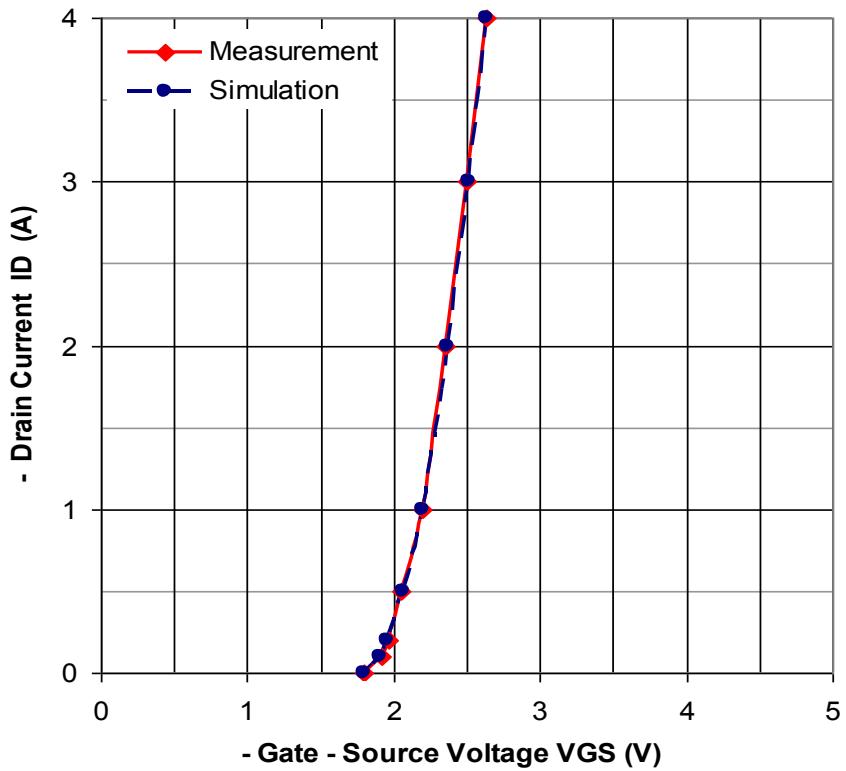


Evaluation circuit



## P-Channel Model Comparison Graph

**Circuit Simulation Result**

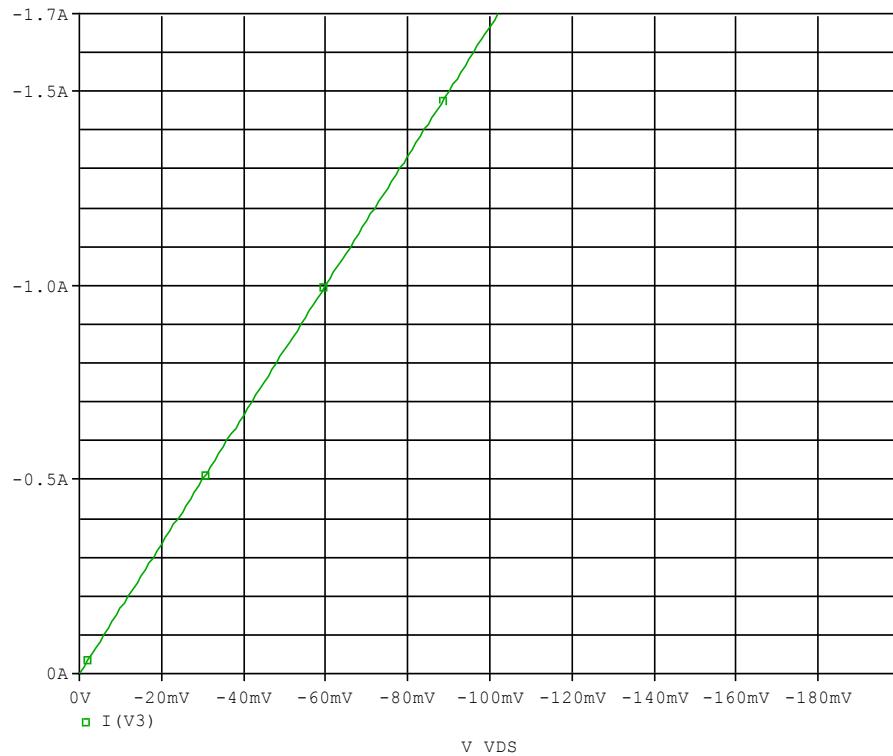


**Simulation Result**

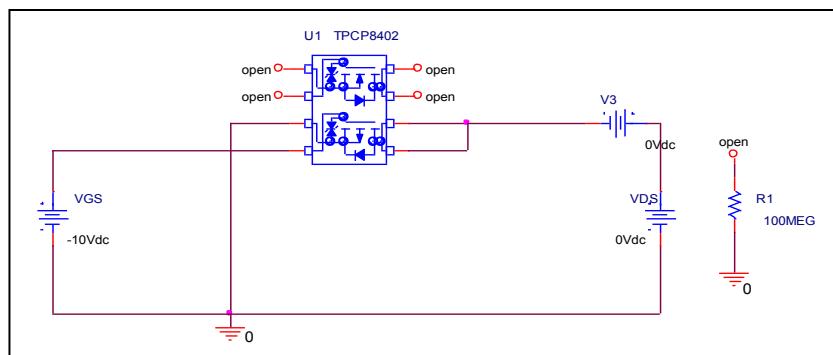
- I <sub>D</sub> (A)	- V <sub>GS</sub> (V)		Error (%)
	Measurement	Simulation	
0	1.8000	1.8000	0.0000
0.1	1.9200	1.9036	-0.8542
0.2	1.9700	1.9580	-0.6091
0.5	2.0500	2.0670	0.8293
1	2.2000	2.1914	-0.3909
2	2.3500	2.3705	0.8723
3	2.5000	2.5104	0.4160
4	2.6300	2.6300	0.0000

## P-Channel Model Rds(on) Characteristic

### Circuit Simulation result



### Evaluation circuit

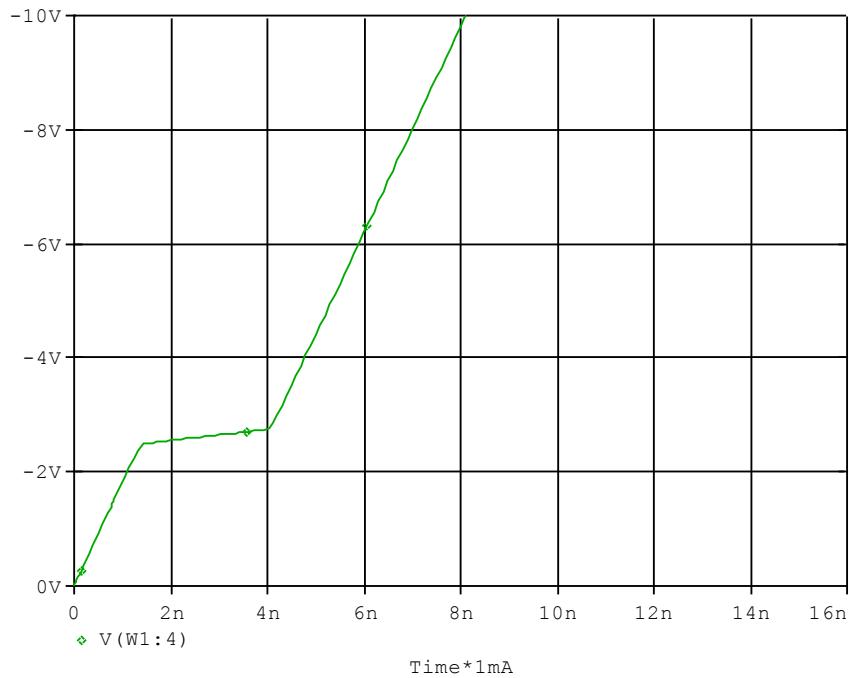


### Simulation Result

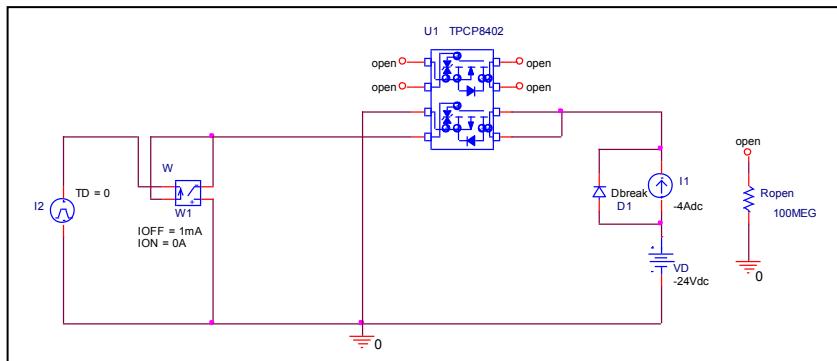
I <sub>D</sub> =-1.7A, V <sub>GS</sub> =-10V	Measurement	Simulation	Error (%)
R <sub>DS</sub> (on)	60 mΩ	60 mΩ	0.000

## P-Channel Model Gate Charge Characteristic

### Circuit Simulation result



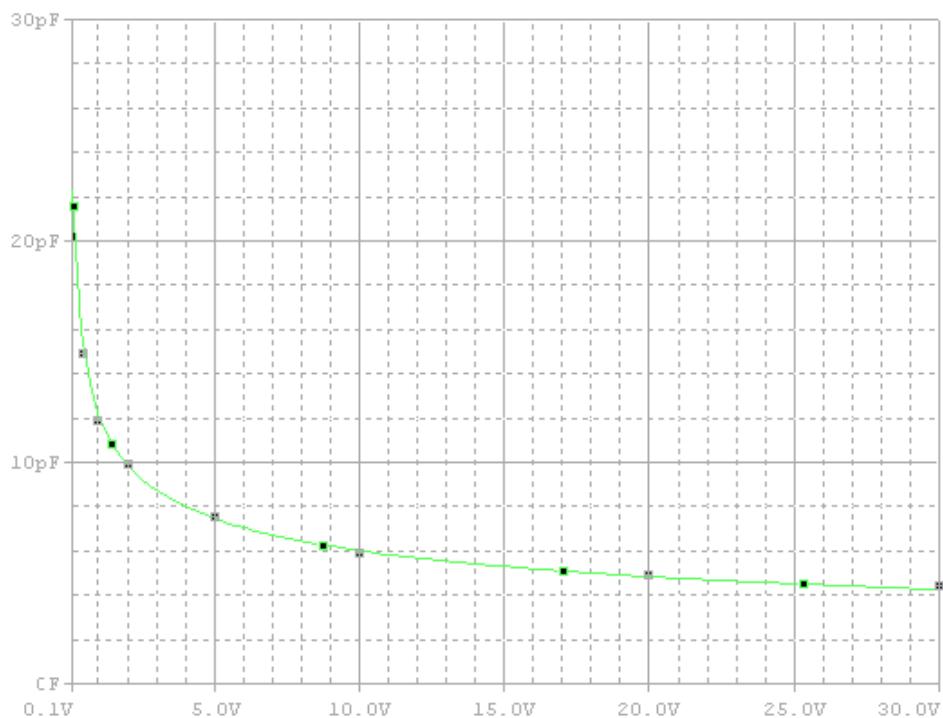
### Evaluation circuit



### Simulation Result

$V_{DD}=-24V, I_D=-3.4A$	Measurement		Simulation		Error (%)
<b>Qgs</b>	<b>1.400</b>	nC	<b>1.4074</b>	nC	<b>0.529</b>
<b>Qgd</b>	<b>2.700</b>	nC	<b>2.6790</b>	nC	<b>-0.778</b>
<b>Qg</b>	<b>14.000</b>	nC	<b>8.1066</b>	nC	<b>-42.096</b>

## P-Channel Model Capacitance Characteristic

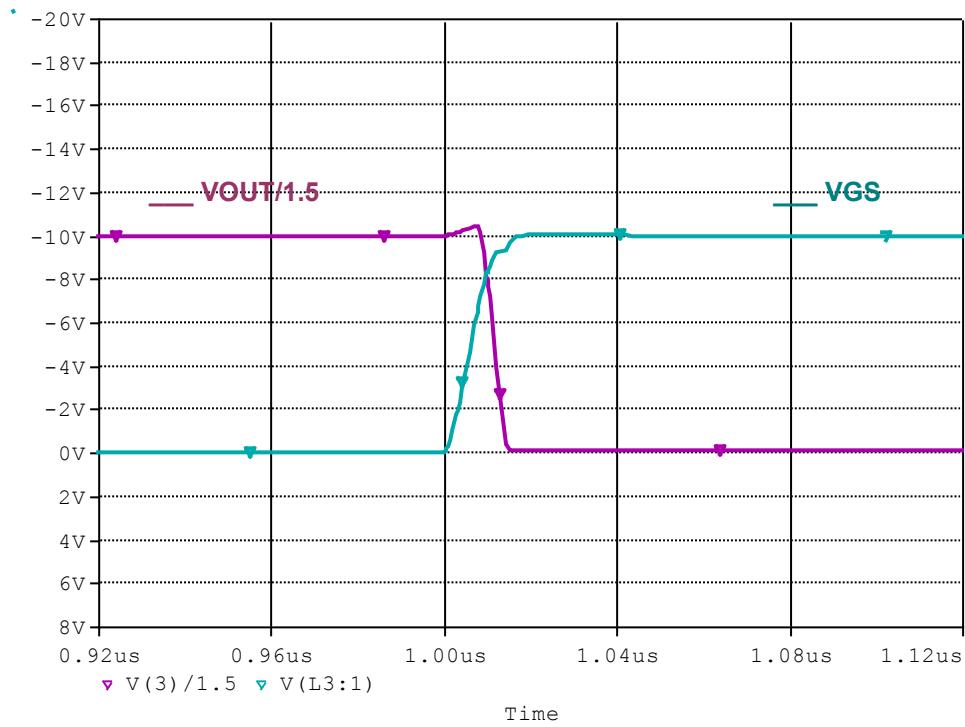


### Simulation Result

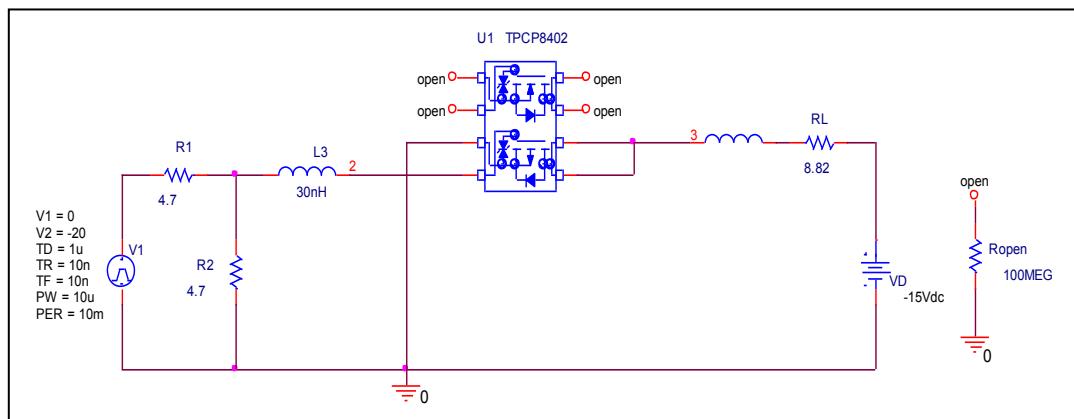
$-V_{DS}$ (V)	C <sub>bd</sub> (pF)		Error(%)
	Measurement	Simulation	
0.5	15.000	15.051	0.340
1	12.000	12.026	0.216
2	10.000	10.187	1.872
5	7.600	7.599	-0.014
10	6.000	6.124	2.070
20	5.000	5.059	1.175
30	4.500	4.566	1.463

## P-Channel Model Switching Time Characteristic

### Circuit Simulation result



### Evaluation circuit

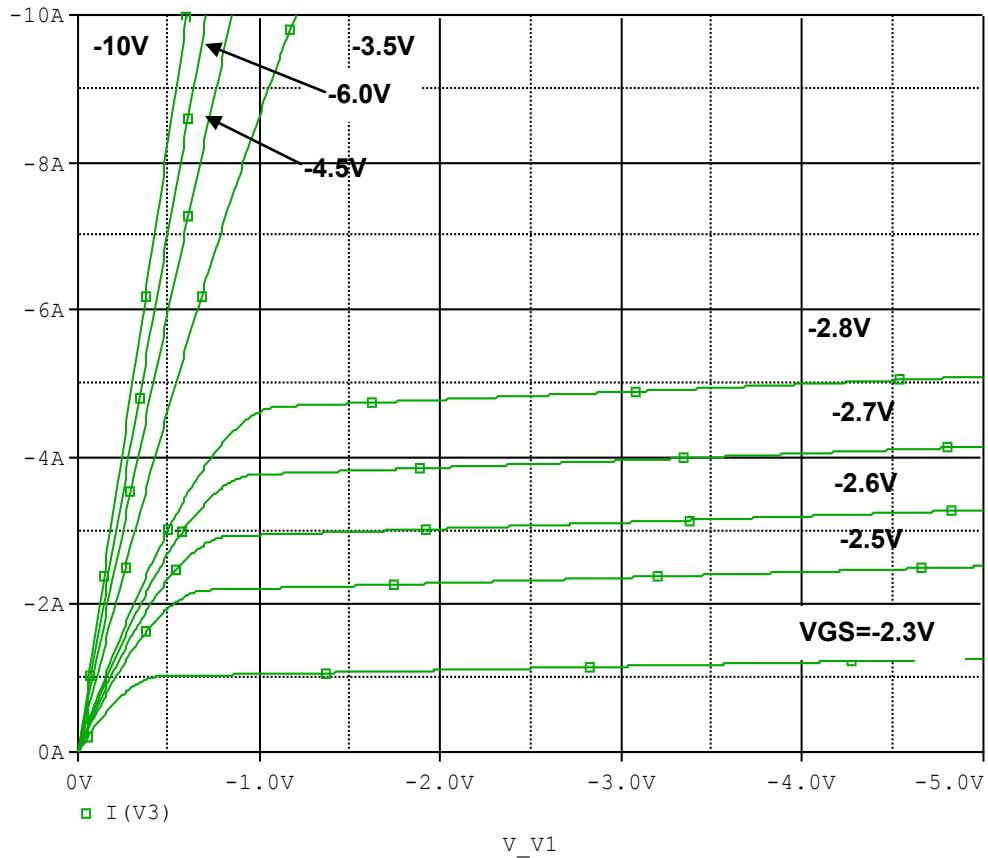


### Simulation Result

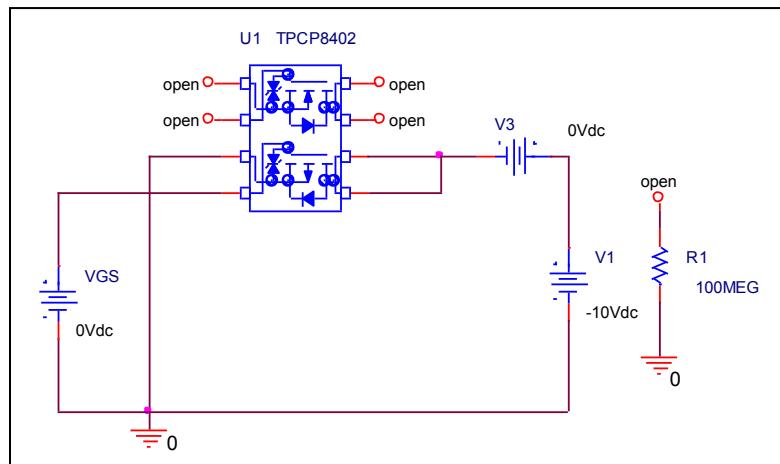
$I_D = -1.7A, V_{DD} = -15V$ $V_{GS} = 0/-10V$	Measurement		Simulation		Error(%)
ton	12.000	ns	11.984	ns	-0.133

## P- Channel Model Output Characteristic

Circuit Simulation result

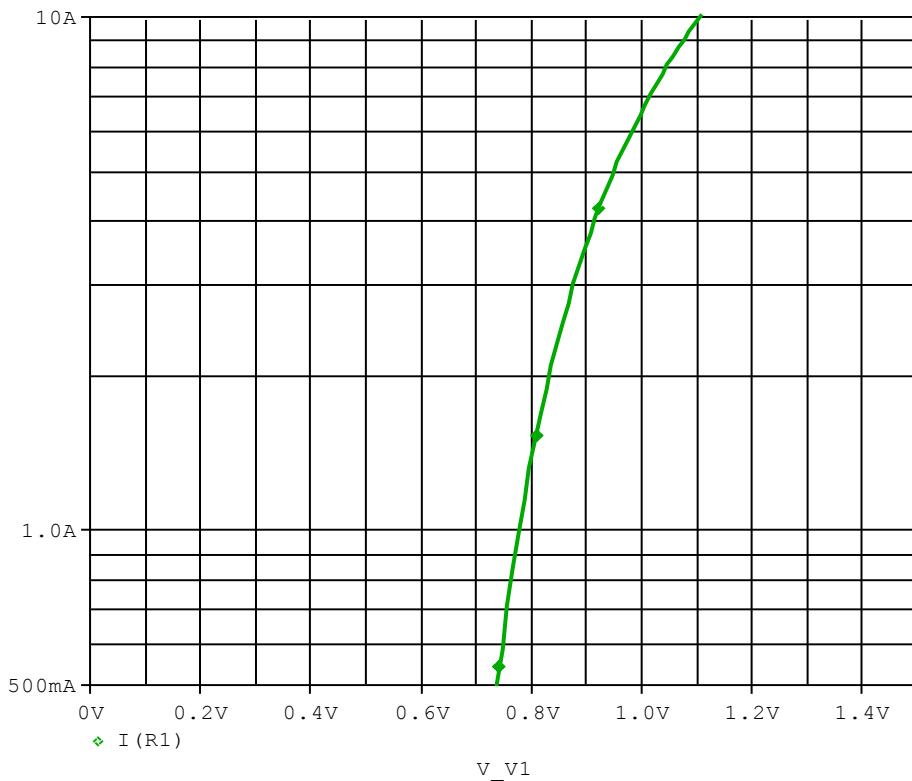


Evaluation circuit

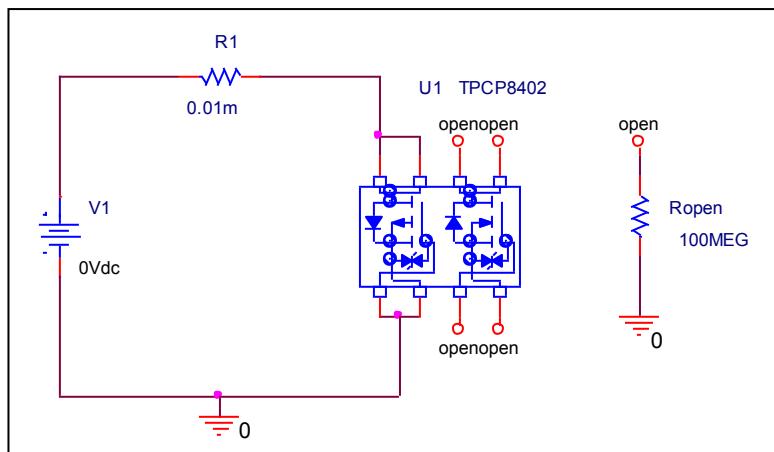


# P-Channel Model BODY DIODE Forward Current Characteristic

Circuit Simulation Result

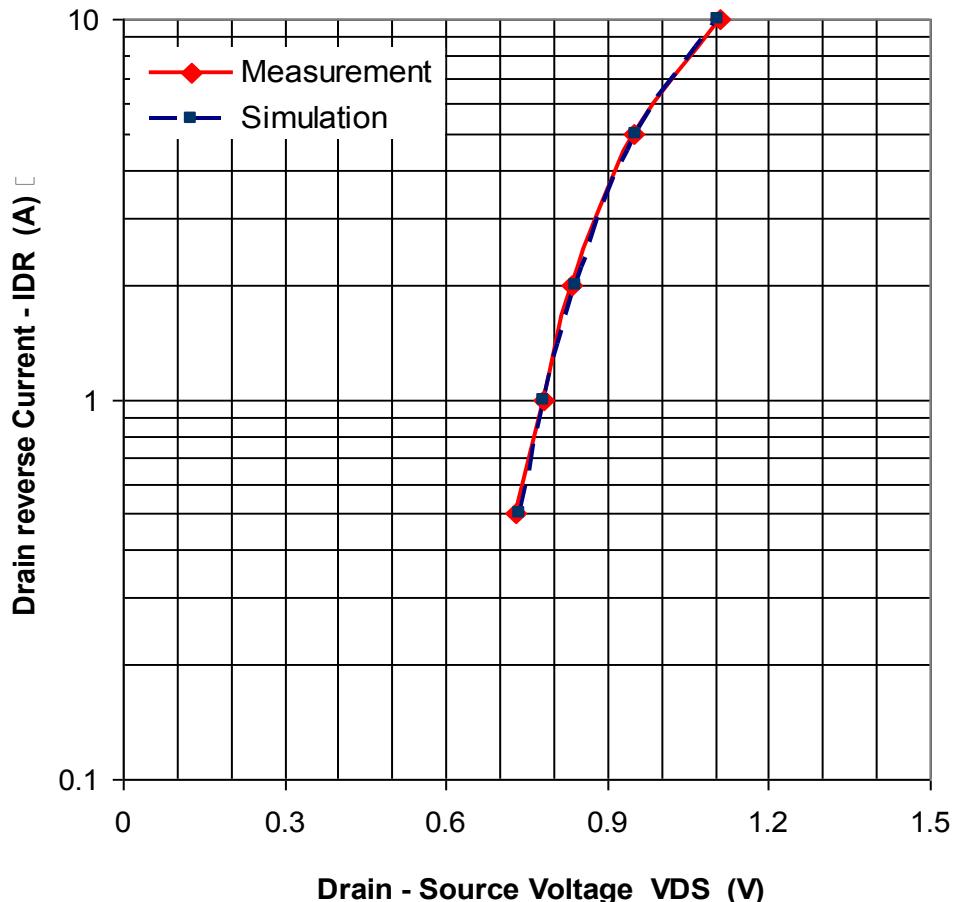


Evaluation Circuit



## P-Channel Model Comparison Graph

Circuit Simulation Result

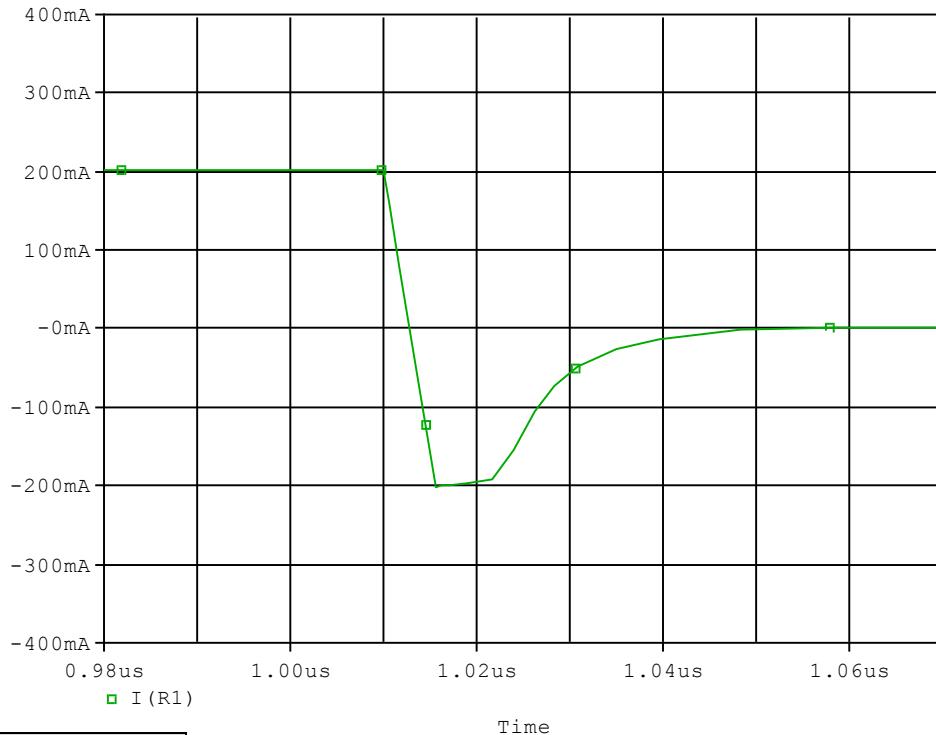


Simulation Result

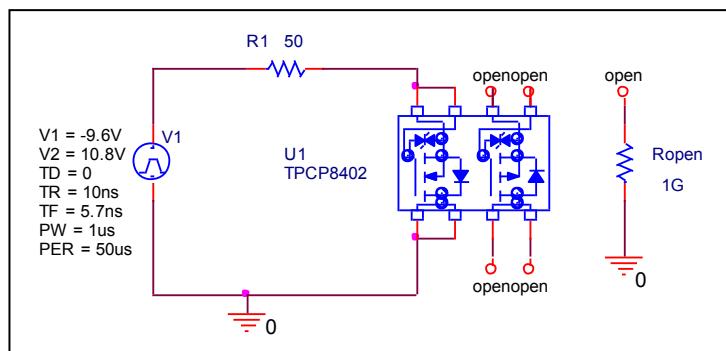
IDR(A)	VSD(V)		%Error
	Measuremen	Simulation	
0.5	0.7300	0.7382	1.1214
1	0.7800	0.7830	0.3846
2	0.8350	0.8399	0.5868
5	0.9500	0.9547	0.4947
10	1.108	1.1062	-0.1625

## P-Channel Model Reverse Recovery Characteristic

### Circuit Simulation Result



### Evaluation Circuit

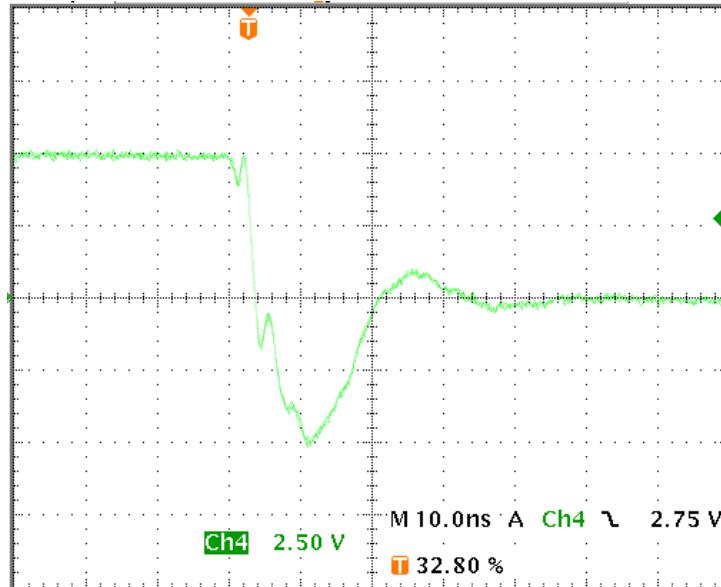


### Compare Measurement vs. Simulation

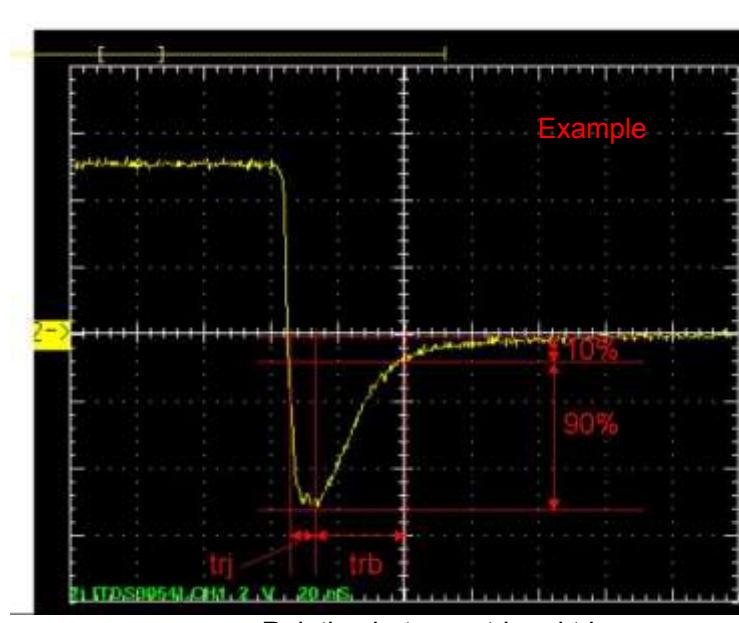
trj (ns)	Measurement	Simulation	Error (%)
trj (ns)	8.600	8.6033	0.038

## P-Channel Model Reverse Recovery Characteristic

Reference



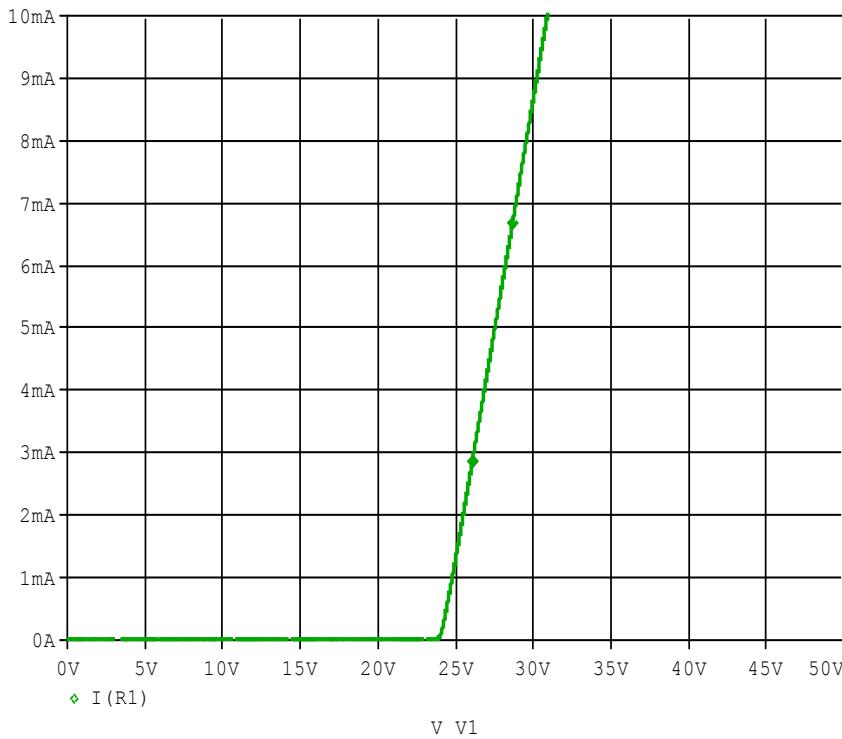
Trj=8.6 (ns)  
Trb=10.2 (ns)  
Conditions: Ifwd=Irev=0.2(A), RI=50



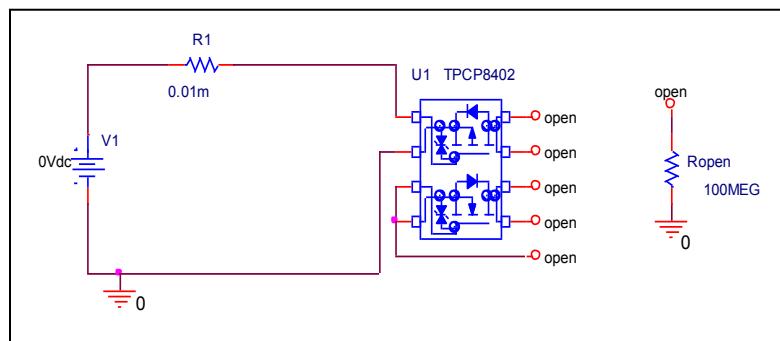
Relation between trj and trb

# P-Channel Model ESD PROTECTION DIODE Zener Voltage Characteristic

## Circuit Simulation Result

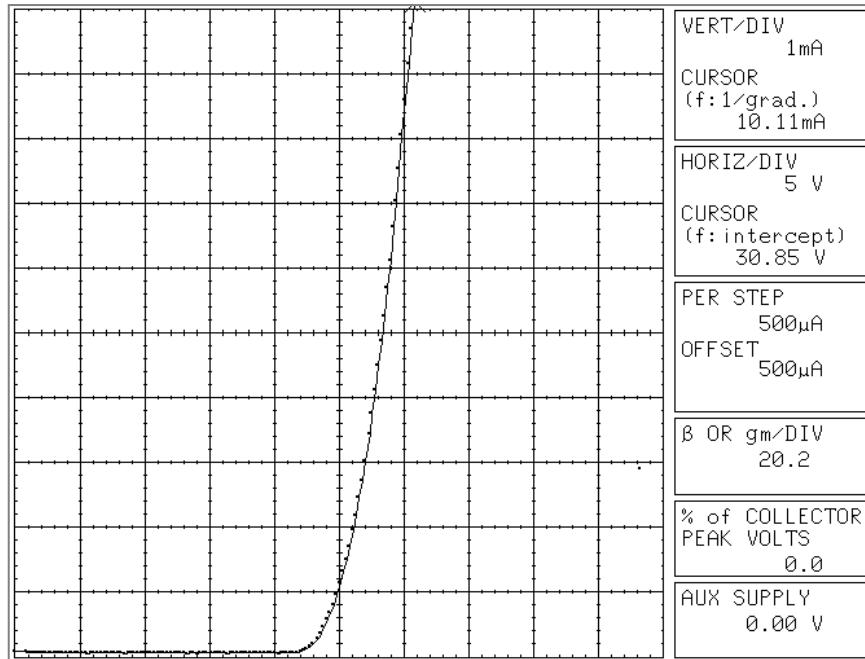


## Evaluation Circuit



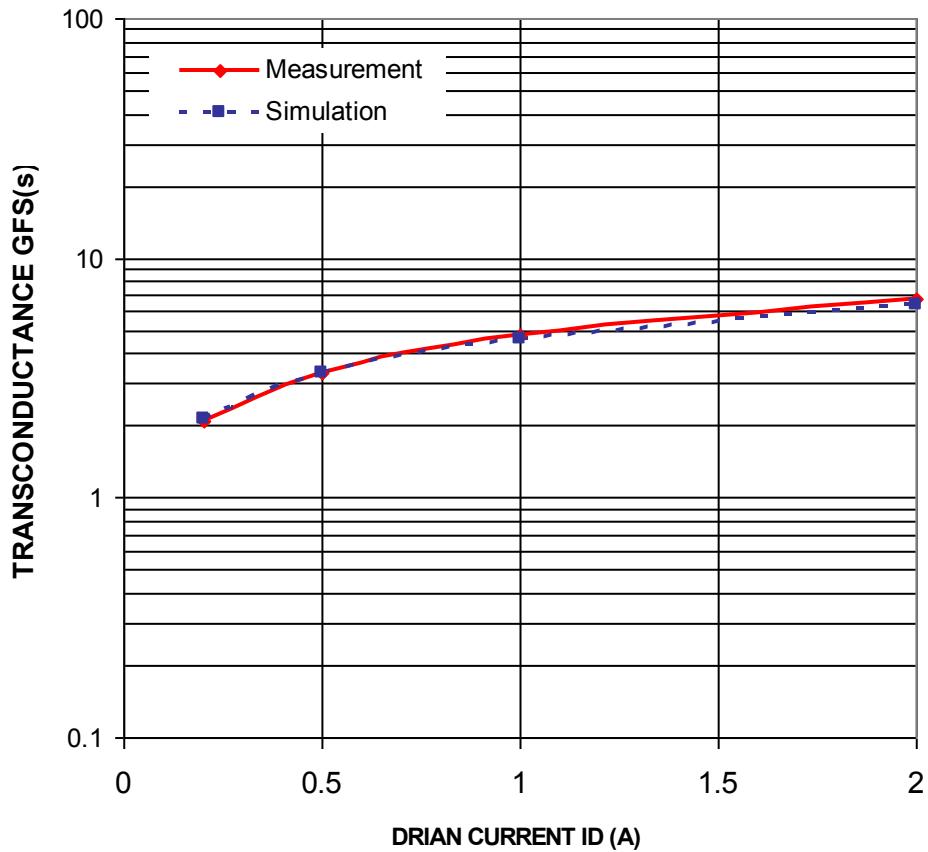
## P-Channel Model Zener Voltage Characteristic

Reference



## N-Channel Model Transconductance Characteristic

Circuit Simulation Result

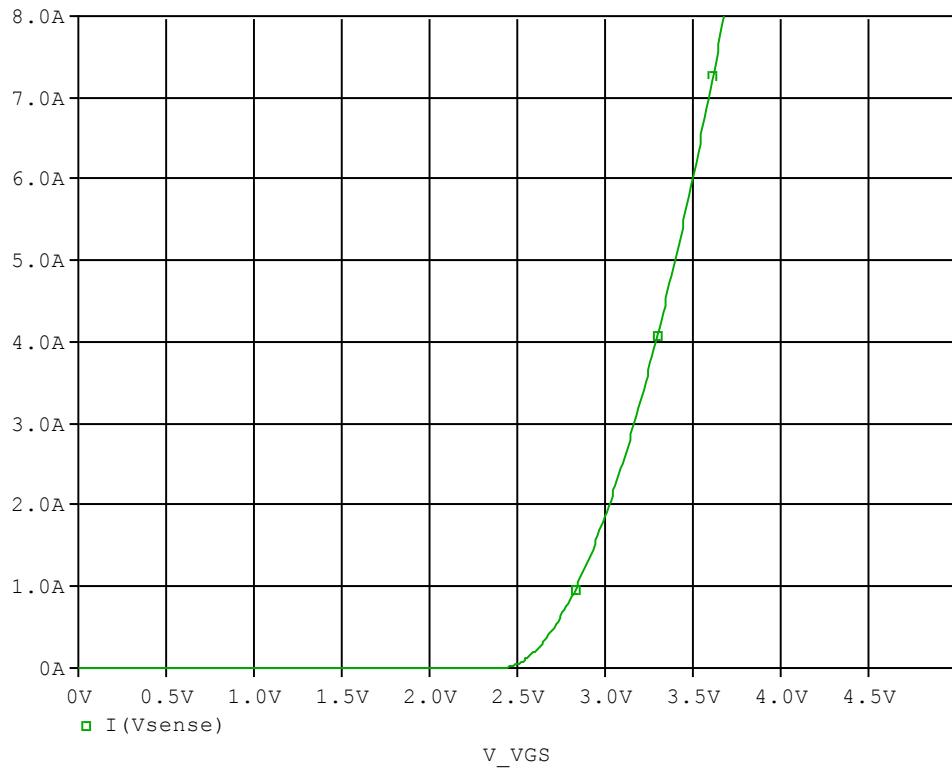


Comparison table

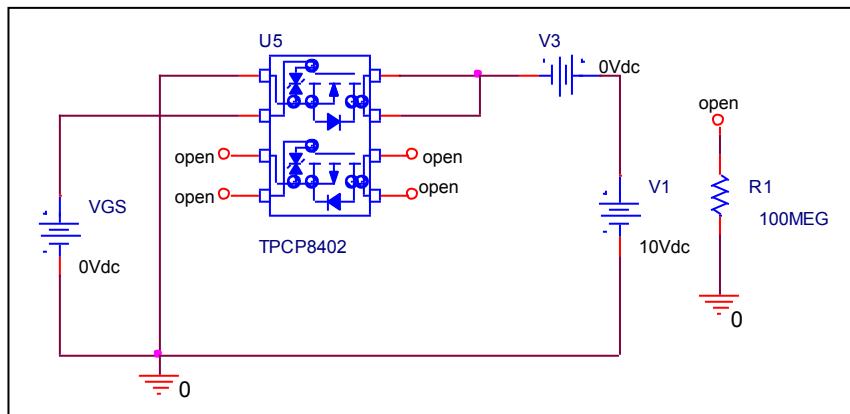
Id(A)	gfs		Error (%)
	Measurement	Simulation	
0.2	2.11	2.13	1.08
0.5	3.33	3.31	-0.66
1	4.65	4.63	-0.46
2	6.67	6.43	-3.59

## N-Channel Model Vgs-Id Characteristic

Circuit Simulation result

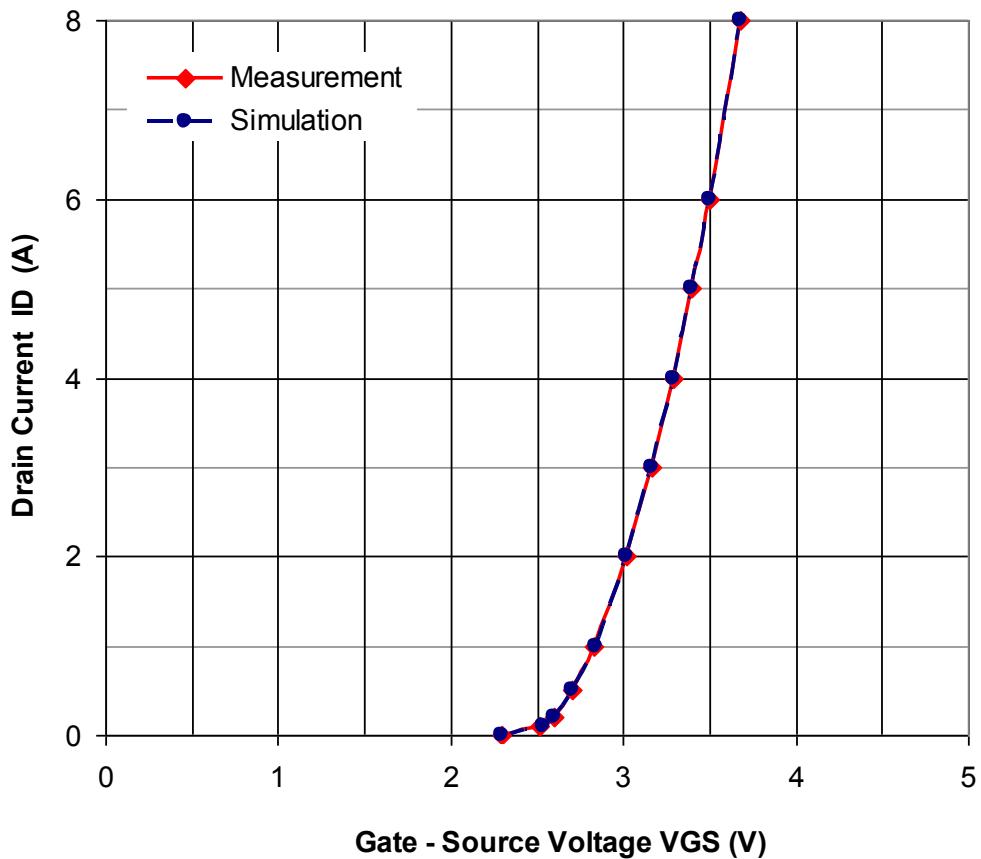


Evaluation circuit



## N-Channel Model Comparison Graph

Circuit Simulation Result

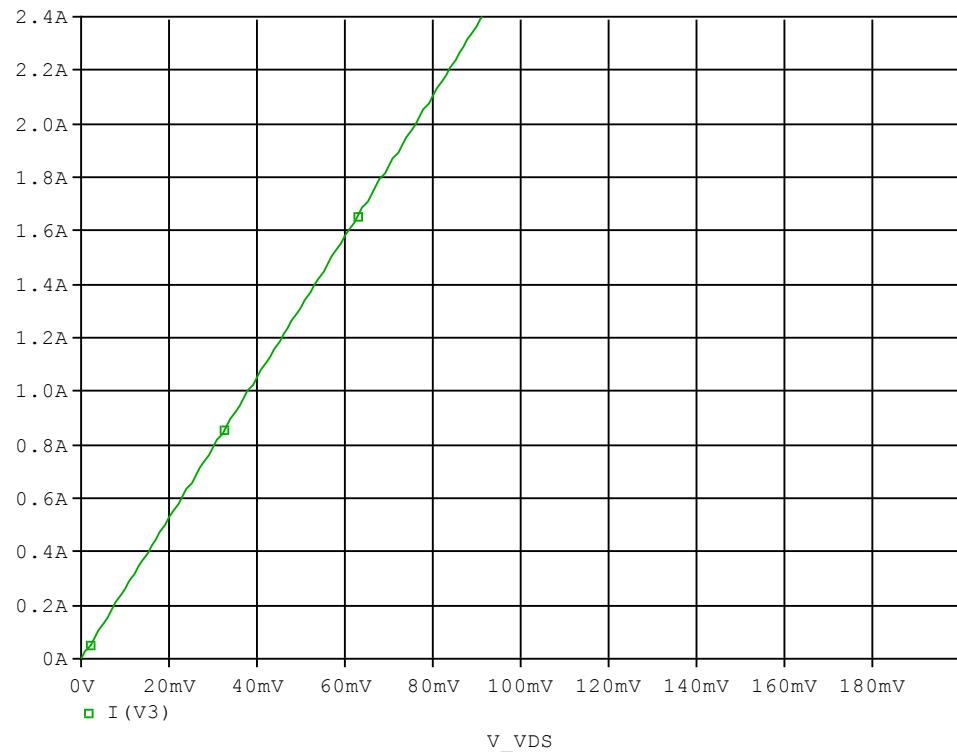


Simulation Result

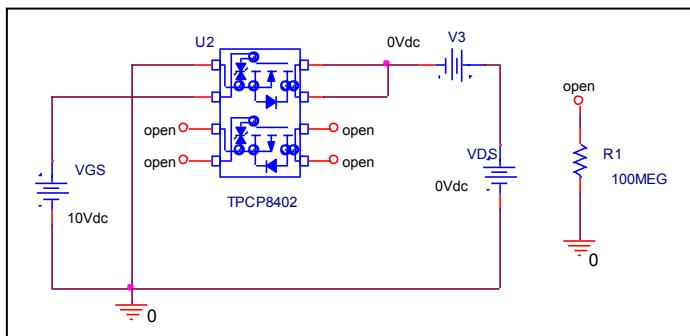
$I_D$ (A)	$V_{GS}$ (V)		Error (%)
	Measurement	Simulation	
0	2.3000	2.3000	0.0000
0.1	2.5200	2.5409	0.8294
0.2	2.6000	2.5971	-0.1115
0.5	2.7000	2.7096	0.3556
1	2.8300	2.8381	0.2862
2	3.0150	3.0227	0.2554
5	3.4000	3.3991	-0.0265
8	3.6800	3.6788	-0.0326

## N-Channel Model Rds(on) Characteristic

### Circuit Simulation result



### Evaluation circuit

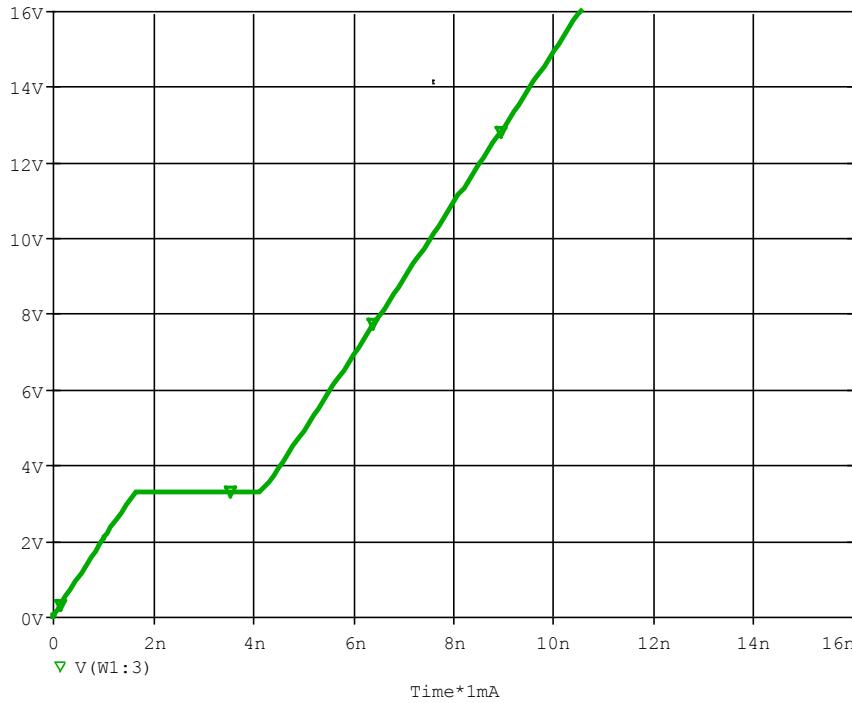


### Simulation Result

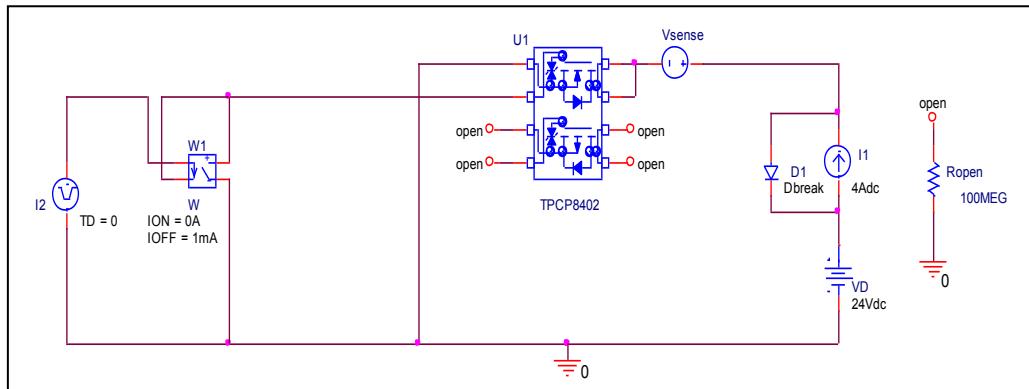
$I_D=2.1A, V_{GS}=10V$	Measurement		Simulation		Error (%)
$R_{DS} \text{ (on)}$	38.000	$m\Omega$	38.000	$m\Omega$	0.000

## N-Channel Model Gate Charge Characteristic

### Circuit Simulation result



### Evaluation circuit

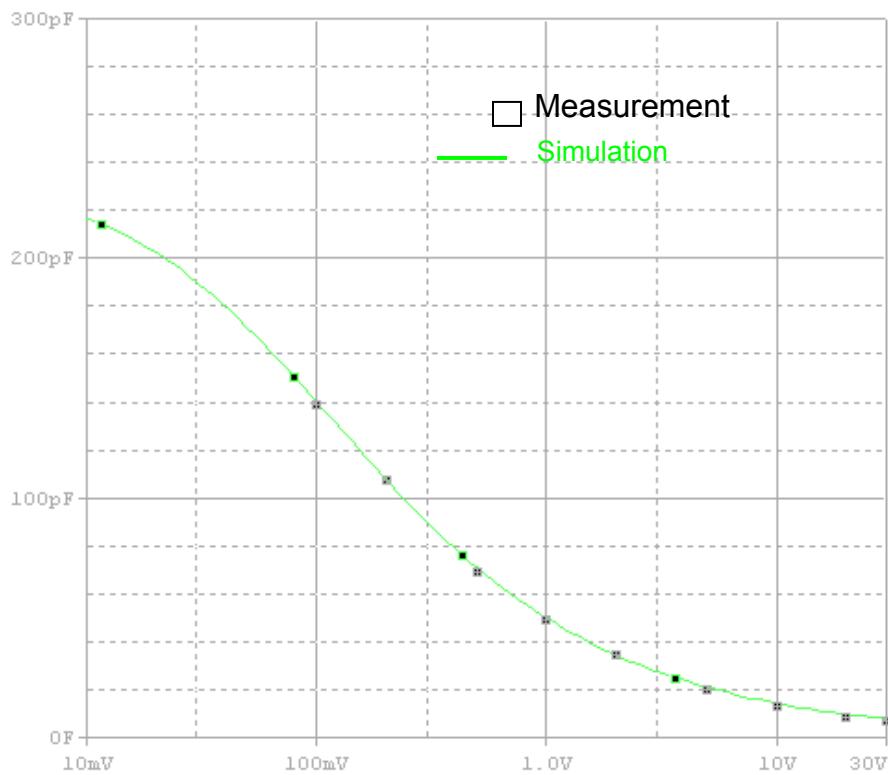


### Simulation Result

$V_{DD}=24V, I_D=4.0A$	Measurement		Simulation		Error (%)
$Q_{gs}$	1.700	nC	1.6964	nC	-0.212
$Q_{gd}$	2.400	nC	2.3978	nC	-0.092
$Q_g$	14.000	nC	7.5500	nC	-46.071

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## N-Channel Model Capacitance Characteristic

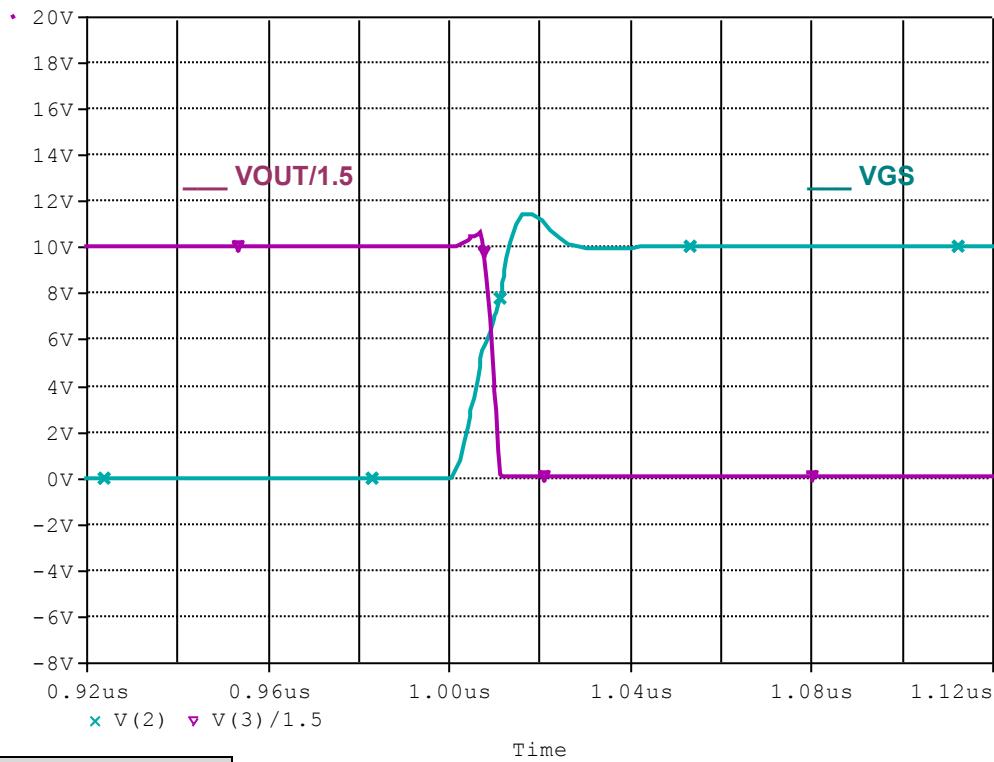


### Simulation Result

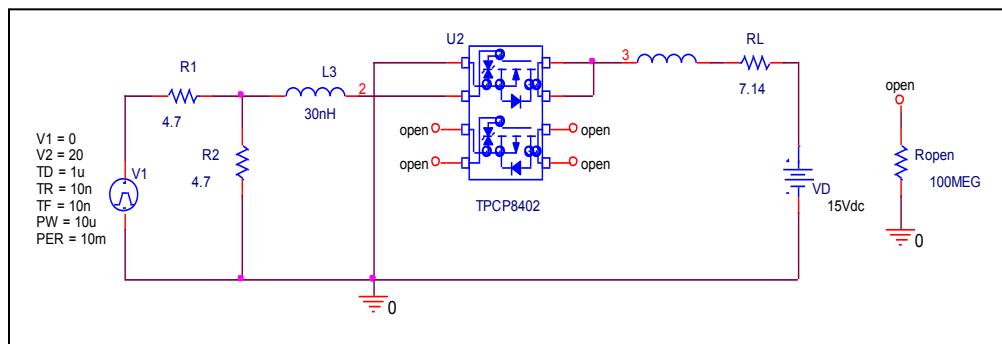
$V_{DS}(V)$	$C_{gd}(pF)$		Error(%)
	Measurement	Simulation	
0.1	140.0000	141.0000	0.7143
0.2	108.0000	107.5000	-0.4630
0.5	70.0000	69.5000	-0.7143
1	50.0000	49.8875	-0.2250
2	35.0000	34.6560	-0.9829
5	21.0000	20.9978	-0.0105
10	14.0000	14.5679	4.0563
20	9.5000	9.6499	1.5774
30	7.5000	7.3527	-1.9642

## N-Channel Model Switching Time Characteristic

### Circuit Simulation result



### Evaluation circuit

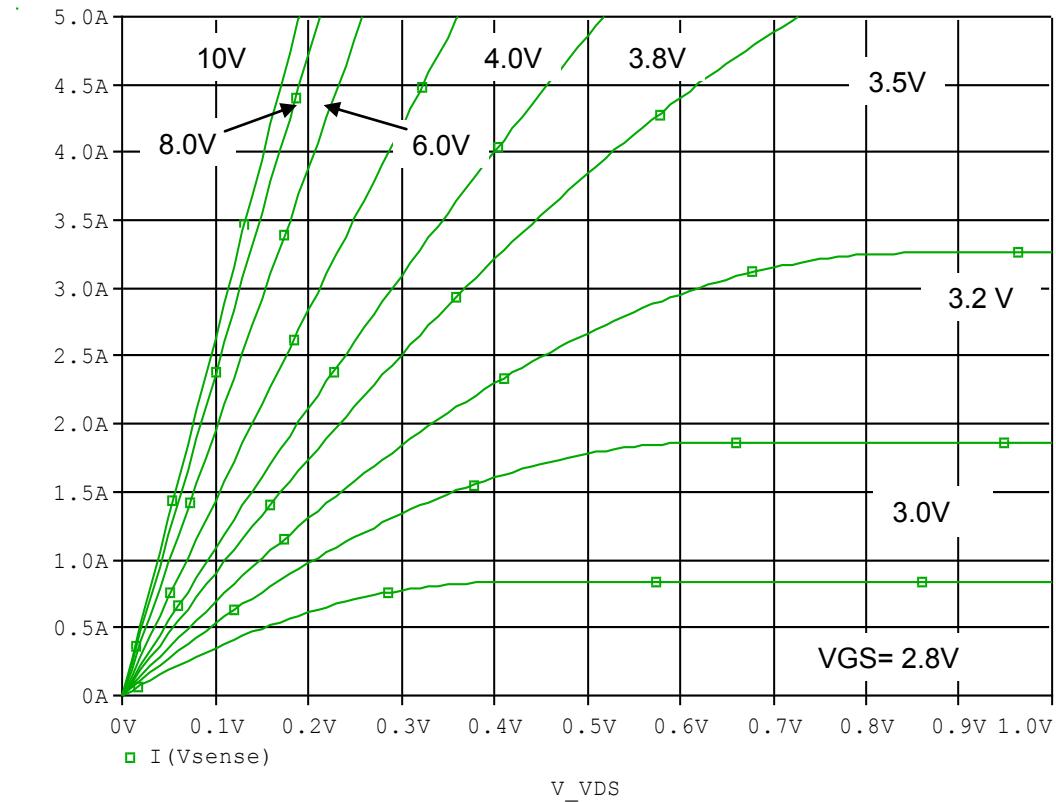


### Simulation Result

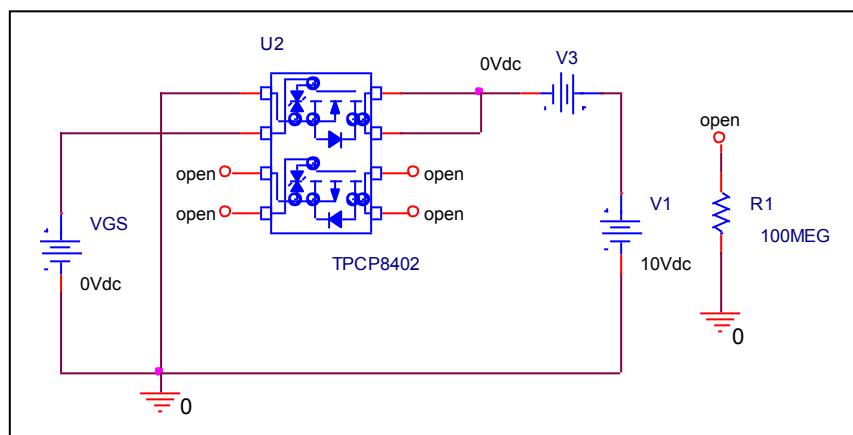
$I_D = 2.1A, V_{DD} = 15V$ $V_{GS} = 0/10V$	Measurement		Simulation		Error(%)
ton	8.300	ns	8.2954	ns	-0.055

## N-Channel Model Output Characteristic

Circuit Simulation result

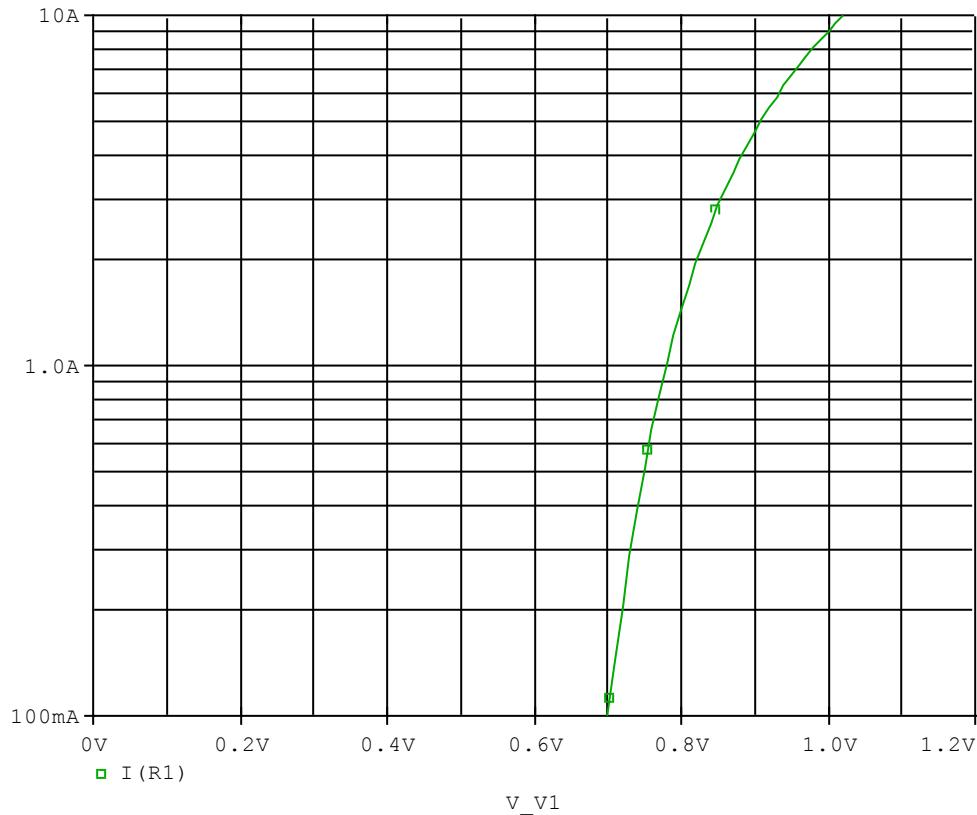


Evaluation circuit

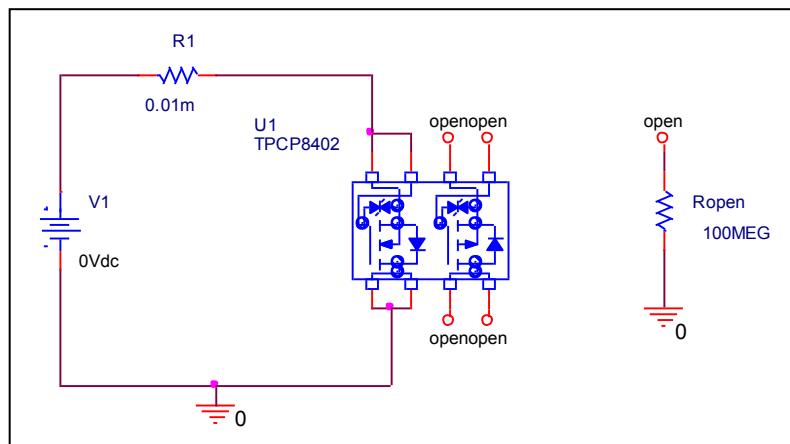


## N-Channel Model BODY DIODE Forward Current Characteristic

### Circuit Simulation Result

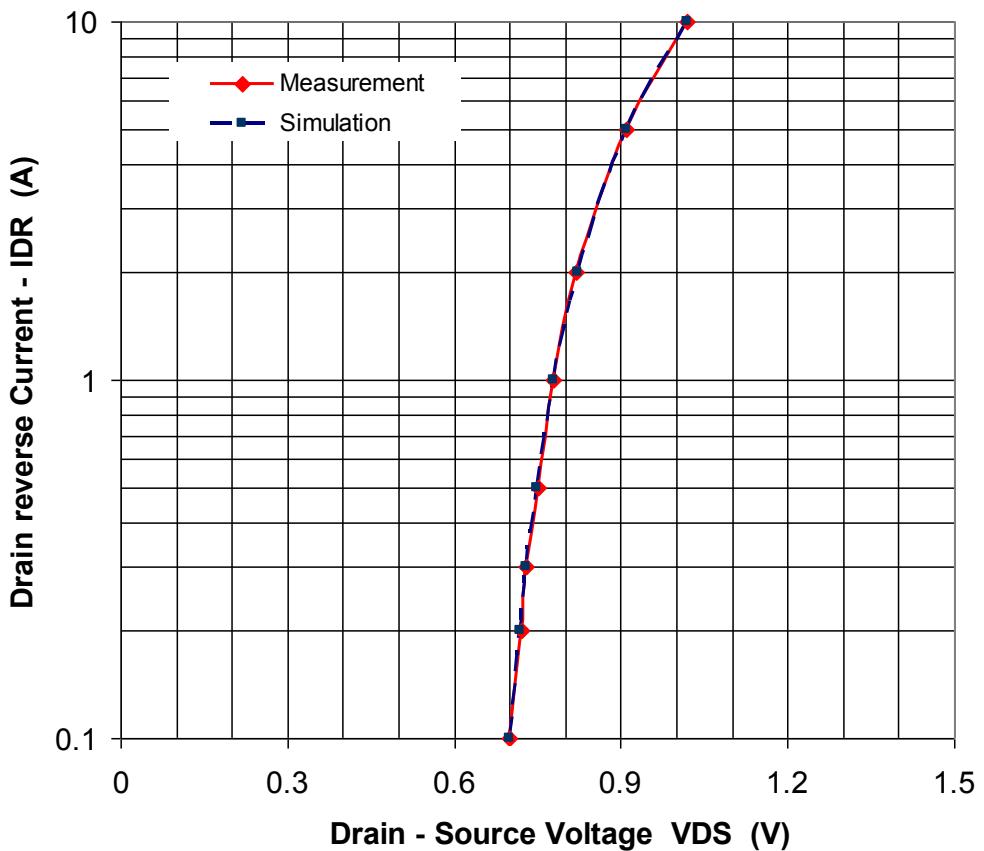


### Evaluation Circuit



## N-Channel Model Comparison Graph

Circuit Simulation Result

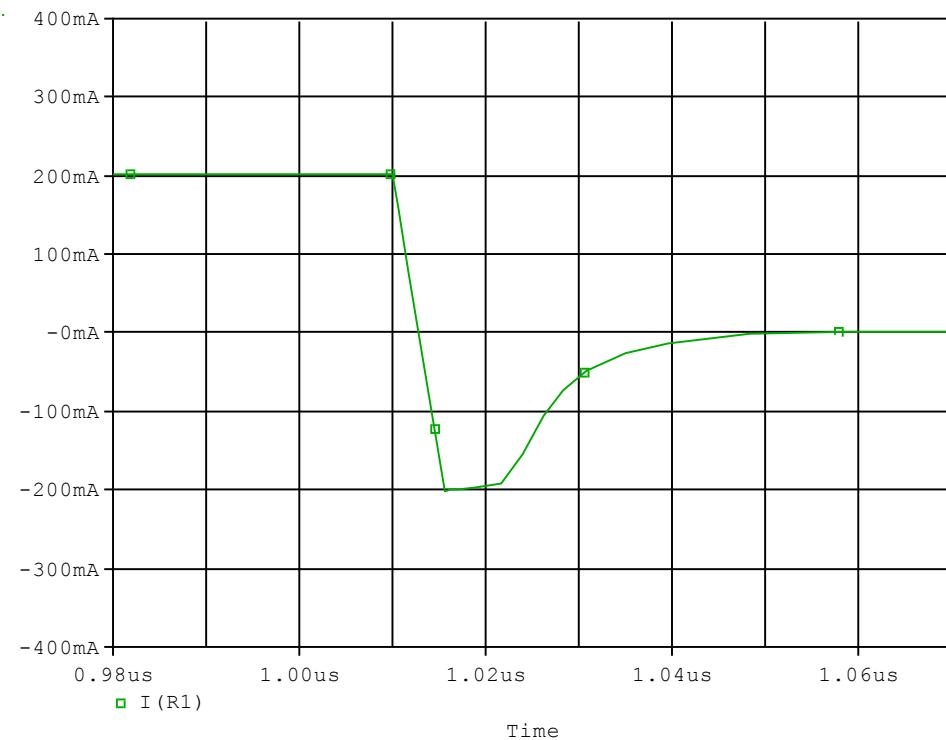


Simulation Result

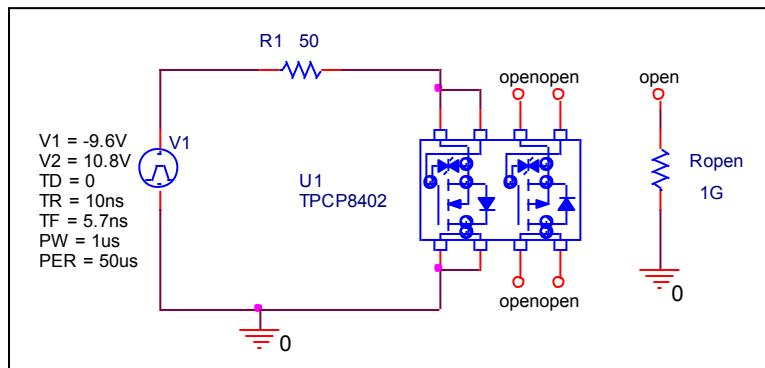
$IDR$ (A)	$V_{SD}$ (V)		%Error
	Measurement	Simulation	
0.1	0.7000	0.6998	-0.0286
0.2	0.7200	0.7190	-0.1389
0.5	0.7500	0.7492	-0.1067
1	0.7800	0.7793	-0.0897
2	0.8200	0.8213	0.1585
5	0.9100	0.9089	-0.1209
10	1.02	1.0204	0.0392

## N-Channel Model Reverse Recovery Characteristic

### Circuit Simulation Result



### Evaluation Circuit

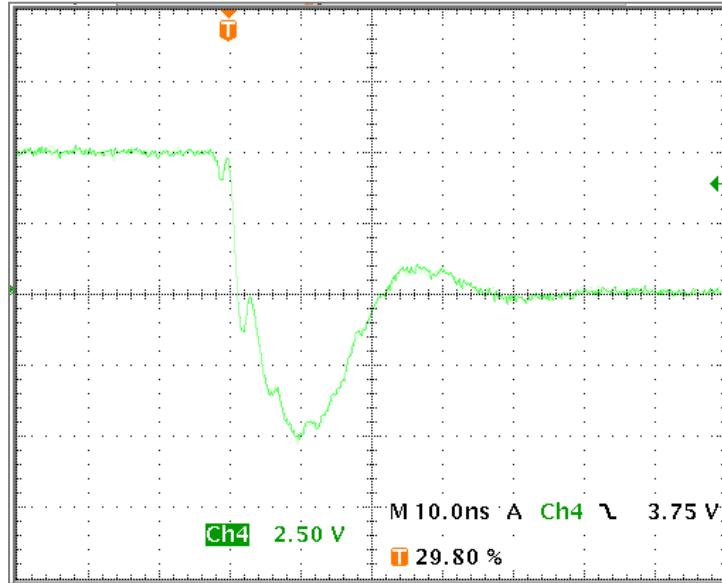


### Compare Measurement vs. Simulation

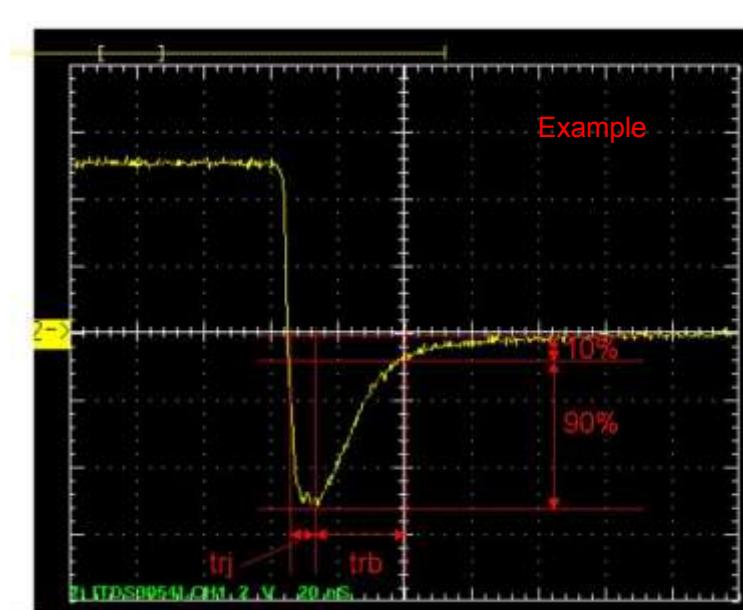
trj (ns)	Measurement	Simulation	Error (%)
trj (ns)	8.600	8.6033	0.038

## N-Channel Model Reverse Recovery Characteristic

Reference



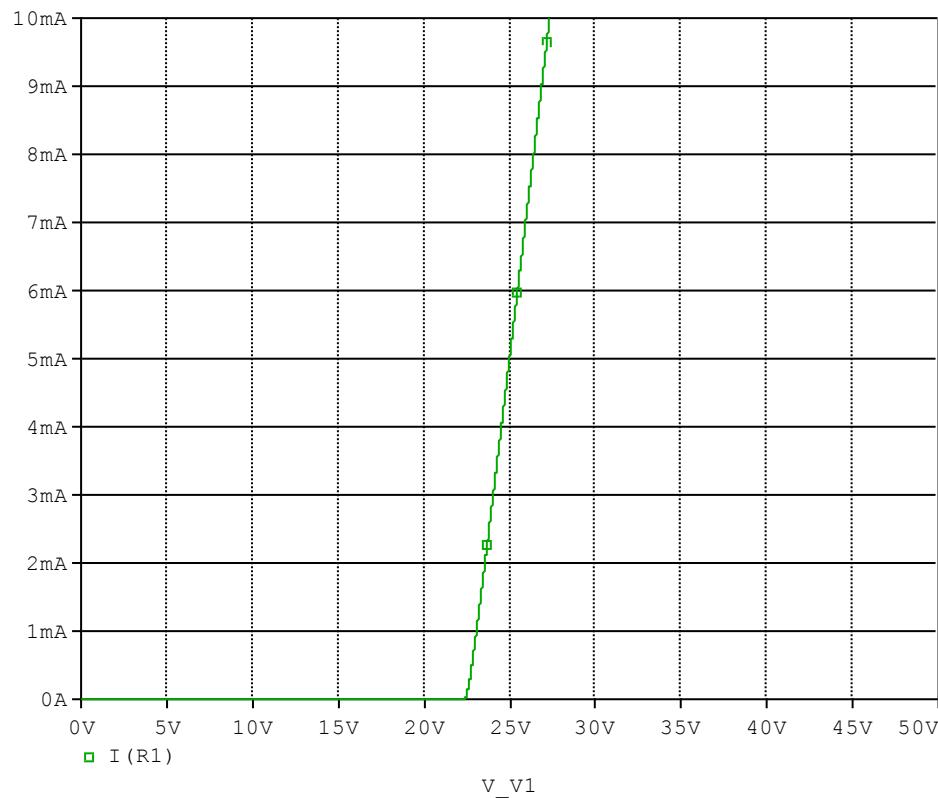
Trj=8.6(ns)  
Trb=10.2(ns)  
Conditions: Ifwd=Irev=0.2(A), RI=50



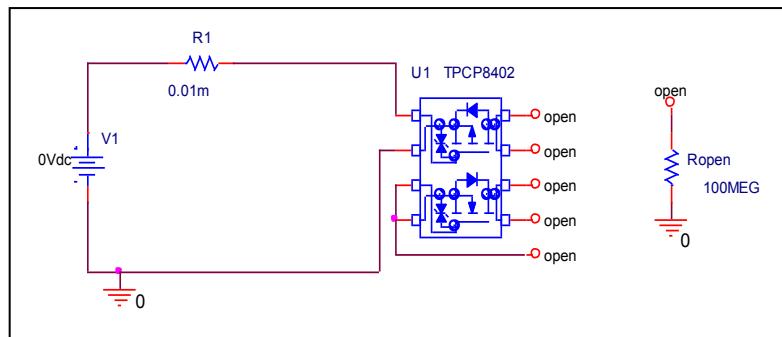
Relation between trj and trb

# N-Channel Model ESD PROTECTION DIODE Zener Voltage Characteristic

## Circuit Simulation Result



## Evaluation Circuit



**N-Channel Model  
Zener Voltage Characteristic**

**Reference**

